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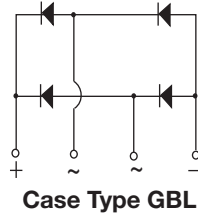
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



## Glass Passivated Single-Phase Bridge Rectifier



### FEATURES

- UL recognition file number E54214
- Ideal for printed circuit boards
- High surge current capability
- Typical  $I_R$  less than 0.1  $\mu\text{A}$
- High case dielectric strength
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT

### TYPICAL APPLICATIONS

General purpose use in AC/DC bridge full wave rectification for monitor, TV, printer, SMPS, adapter, audio equipment, and home appliances applications.

### MECHANICAL DATA

**Case:** GBL

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-E3 - RoHS-compliant, commercial grade

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test

**Polarity:** As marked on body

PRIMARY CHARACTERISTICS	
Package	GBL
$I_{F(AV)}$	1.5 A
$V_{RRM}$	200 V, 600 V, 800 V
$I_{FSM}$	60 A
$I_R$	5 $\mu\text{A}$
$V_F$ at $I_F = 0.75 \text{ V}$	1.0 V
$T_J$ max.	150 °C
Diode variations	In-Line

MAXIMUM RATINGS ( $T_A = 25 \text{ }^\circ\text{C}$ unless otherwise noted)					
PARAMETER	SYMBOL	G2SBA20	G2SBA60	G2SBA80	UNIT
Maximum repetitive peak reverse voltage	$V_{RRM}$	200	600	800	V
Maximum RMS voltage	$V_{RMS}$	140	420	560	V
Maximum DC blocking voltage	$V_{DC}$	200	600	800	V
Maximum average forward rectified output current at $T_A = 25 \text{ }^\circ\text{C}$	$I_{F(AV)}$	1.5			A
Peak forward surge current single sine-wave superimposed on rated load	$I_{FSM}$	60			A
Rating for fusing ( $t < 8.3 \text{ ms}$ )	$I^2t$	15			$\text{A}^2\text{s}$
Operating junction and storage temperature range	$T_J, T_{STG}$	- 55 to + 150			$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ( $T_A = 25 \text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS	SYMBOL	G2SBA20	G2SBA60	G2SBA80	UNIT
Maximum instantaneous forward voltage drop per diode	0.75 A	$V_F$	1.00			V
Maximum DC reverse current at rated DC blocking voltage per diode	$T_A = 25 \text{ }^\circ\text{C}$	$I_R$	5.0			$\mu\text{A}$
	$T_A = 125 \text{ }^\circ\text{C}$		300			



THERMAL CHARACTERISTICS ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)					
PARAMETER	SYMBOL	G2SBA20	G2SBA60	G2SBA80	UNIT
Typical thermal resistance	$R_{\theta JA}$	40			$^\circ\text{C/W}$
	$R_{\theta JC}$	12			

**Note**

- Unit mounted on PCB with 0.5" x 0.5" (12 mm x 12 mm) copper pads and 0.375" (9.5 mm) lead length

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
G2SBA60-E3/45	2.017	45	20	Tube
G2SBA60-E3/51	2.017	51	400	Anti-static PVC tray

**RATINGS AND CHARACTERISTICS CURVES ( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)**

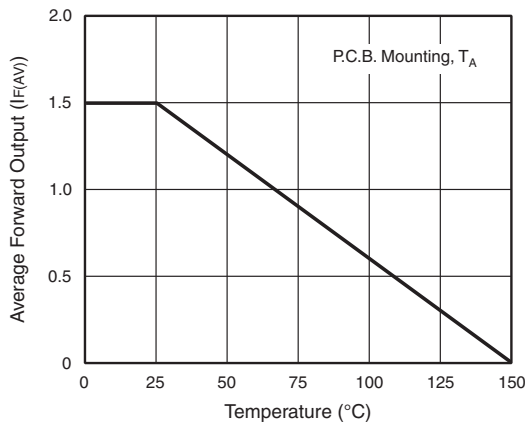


Fig. 1 - Derating Curve Output Rectified Current

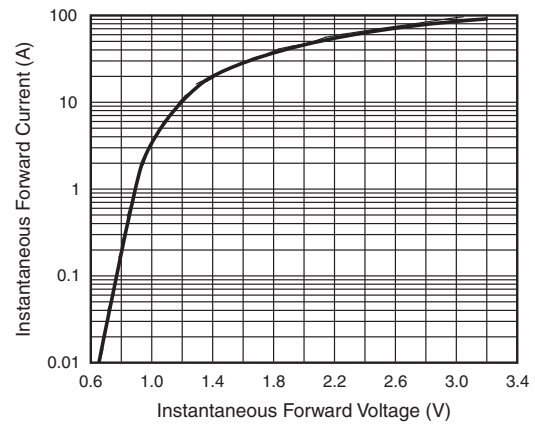


Fig. 3 - Typical Forward Characteristics Per Diode

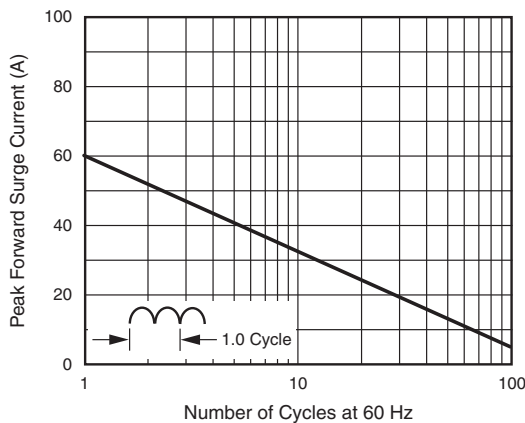


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current Per Diode

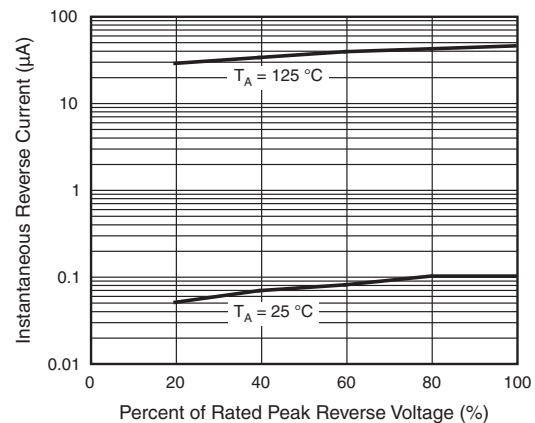


Fig. 4 - Typical Reverse Characteristics Per Diode



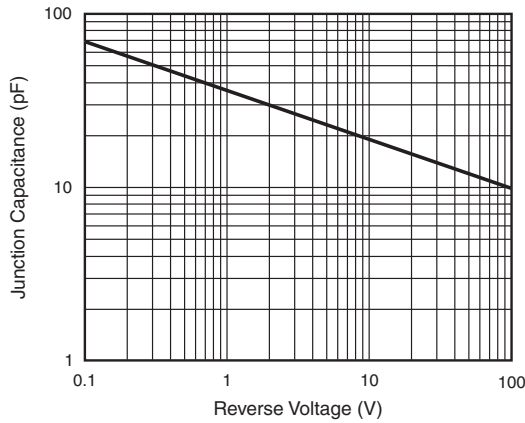


Fig. 5 - Typical Junction Capacitance Per Diode

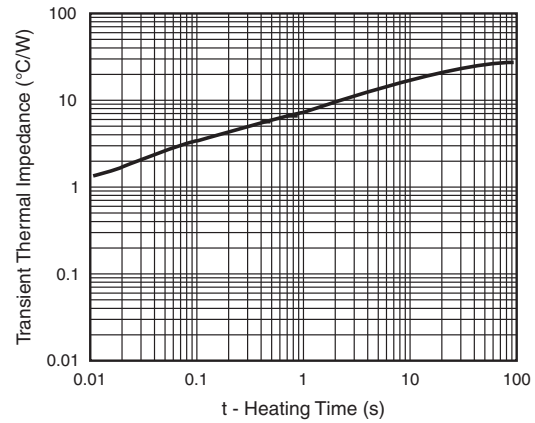
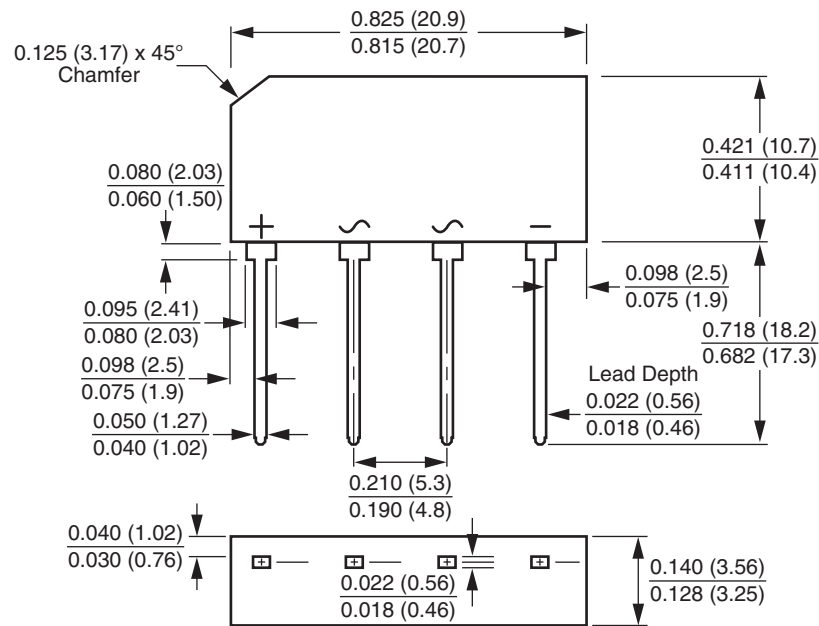


Fig. 6 - Typical Transient Thermal Impedance

## PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

### Case Type GBL



Polarity shown on front side of case, positive lead beveled corner



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